



How to program/reprogram the ST10F269Zx Flash memory

Introduction

This application note provides software guidelines and examples to program the ST10F269Zx. More generally, this application note is applicable to any ST10 variant with an 0.35 μm technology embedded Flash memory.

The first section gives an overview of the ST10F269Zx embedded Flash memory's key features. It also shows the differences between the ST10F269Zx and ST10F168.

The second section describes how to develop software for the ST10F269Zx embedded Flash memory through guidelines, examples and tips.

The last section is dedicated to embedded application aspects. More specifically, it gives advices for Flash memory field reprogramming.

This application note does not replace the ST10F269Zx product datasheet. It refers to it and it is necessary to have a copy of it to follow some of the explanations.

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1 Introduction to ST10F269Zx 0.35 μ m embedded Flash memory

This section describes the improvements made from the ST10F168 and the differences with standalone Flash memories.

1.1 Differences with ST10F168

1.1.1 Single supply

ST10 variants with 0.35 μ m embedded Flash memories do not require specific a supply for programming. On-chip charge pumps provide the necessary supply from the external single 5 V supply.

1.1.2 New Erase/Program Controller

The 0.35 μ m Erase/Program Controller was changed to be more similar to the one of standalone Flash memories: erasing and programming of Flash memory cells is no more done by the ST10. This allows:

- **Savings on system stack:** Space no longer needs allocated on the ST10 system stack for erasing and programming,
- **Improved efficiency during programming:** ST10 CPU can be used to handle communication during the time where the Erase/Program Controller is dealing with the Flash memory
- **Improved clock scheme:** the Flash Erase/Program Controller has its own clock; there is no more need to specify it to the CPU clock. This also simplifies the handling of special events (like PLL unlock) during erasing/programming.

1.1.3 Improved granularity of block sizes

The ST10F269Zx 0.35 μ m embedded Flash memory has an improved block granularity (smaller blocks) and also features a boot block organization:

- Block size is 64 Kbytes for standard blocks,
- Small blocks for the 4 boot blocks (16 Kbyte, then 8 Kbyte, 8 Kbyte, 32 Kbyte).

1.2 Comparison with Standalone Flash memories

1.2.1 Similar but different erase/program commands

The Erase/Program Controller of ST10F269Zx is derived from the Common Flash memory Interface:

- To keep the same level of proven safety, the special sequence of commands of standalone Flash memories has been kept,
- To differentiate embedded Flash memories from external Flash memories, the value of the commands (addresses and data) have been slightly modified.

1.2.2 Description of the commands to the Flash memory Erase/Program Controller

[Table 1](#) describes the commands allowed with the ST10F269Zx Erase/Program Controller.

Commands to the Flash memory are defined by a sequence of ST10F269Zx write cycles with specific addresses and data within the Flash memory address range. The length of the sequence varies from 1 cycle (e.g.: Read/Reset) to 6 cycles (Chip Erase).

The Block Erase command can be extended by 1 cycle per additional block to erase. This translates in a maximum of 12 cycles for the ST10F269Zx.

Table 1. Commands for ST10 with 0.35 µm embedded Flash memory⁽¹⁾

Instruction	Mne	Cycle	Address/ Data	1 st cycle	2 nd cycle	3 rd cycle	4 th cycle	5 th cycle	6 th cycle	7 th cycle
Read/Reset	RD	1+	Addr. ⁽²⁾	X	Read Memory Array until a new write cycle is initiated					
			Data	xxF0h						
Read/Reset	RD	3+	Addr. ⁽²⁾	x1554h	x2AA8h	xxxxxh	Read Memory Array until a new write cycle is initiated			
			Data	xxA8h	xx54h	xxF0h				
Program Word	PW	4	Addr. ⁽²⁾	x1554h	x2AA8h	x1554h	WA	Read Data Polling or Toggle bit until program completes.		
			Data	xxA8h	xx54h	xxA0h	WD			
Block Erase	BE	6	Addr. ⁽²⁾	x1554h	x2AA8h	x1554h	x1554h	x2AA8h	BA	BA ¹⁽³⁾
			Data	xxA8h	xx54h	xx80h	xxA8h	xx54h	xx30h	xx30h
Chip Erase	CE	6	Addr. ⁽²⁾	x1554h	x2AA8h	x1554h	x1554h	x2AA8h	x1554h	Note ⁽⁴⁾
			Data	xxA8h	xx54h	xx80h	xxA8h	xx54h	xx10h	
Erase Suspend	ES	1	Addr. ⁽²⁾	X	Read until Toggle stops, then read or program all data needed from block(s) not being erased then Resume Erase.					
			Data	xxB0h						
Erase Resume	ER	1	Addr. ⁽²⁾	X	Read Data Polling or Toggle bit until Erase completes or Erase is suspended another time.					
			Data	xx30h						
Set Block/Code Protection	SP	4	Addr. ⁽²⁾	x2A54h	x15A8h	x2A54h	Any odd word address ⁽⁵⁾			
			Data	xxA8h	xx54h	xxC0h	WPR ⁽⁶⁾			

Table 1. Commands for ST10 with 0.35 µm embedded Flash memory⁽¹⁾ (continued)

Instruction	Mne	Cycle	Address/ Data	1 st cycle	2 nd cycle	3 rd cycle	4 th cycle	5 th cycle	6 th cycle	7 th cycle
Read Protection Status	RP	4	Addr. ⁽²⁾	x2A54h	x15A8h	x2A54h	Any odd word address ⁽⁵⁾	Read Protection Register until a new write cycle is initiated.		
			Data	xxA8h	xx54h	xx90h	Read PR			
Block Temporary Unprotection	BTU	4	Addr. ⁽²⁾	x2A54h	x15A8h	x2A54h	X			
			Data	xxA8h	xx54h	xxC1h	xxF0h			
Code Temporary Unprotection	CTU	1	Addr. ⁽²⁾	MEM ⁽⁷⁾	Write cycles must be executed from Flash.					
			Data	FFFFh						
Code Temporary Protection	CTP	1	Addr. ⁽²⁾	MEM ⁽⁷⁾	Write cycles must be executed from Flash.					
			Data	FFFBh						

- Mne = mnemonic, X = Don't Care.
WA = Write Address: address of memory location to be programmed.
WD = Write Data: 16-bit data to be programmed.
BA = Block address.
- Address bit A14, A15 and above are don't care for coded address inputs.
- Optional, additional blocks addresses must be entered within a timeout delay (96 µs) after last write entry, timeout status can be verified through FSB.3 value. When full command is entered, read Data Polling or Toggle bit until Erase is completed or suspended.
- Read data polling or toggle bit until erase completes.
- Odd word address = 4n-2 where n = 0, 1, 2, 3..., e.g. 0002h, 0006h, etc.
- WPR = Write protection register. To protect code, bit 15 of WPR must be '0'. To protect block N (N=0,1,...), bit N of WPR must be '0'. Bit that are already at '0' in protection register must also be '0' in WPR, else a writing error will occurs (it is not possible to write a '1' in a bit already programmed at '0').
- MEM = any address inside the Flash memory space. Absolute addressing mode must be used (MOV MEM, Rn), and instruction must be executed from Flash memory space.

Flash commands and ST10 pipeline effect

Due to the ST10F269Zx pipeline effect, all erase and program commands must *not* be immediately followed by a JMPx, CALLx or RETx instruction.

For any erase or program command, a NOP instruction must be inserted after sending the last command to the Flash memory Erase/Program Controller.

When not implemented, and when the ST10F269Zx is in bootstrap mode with the code running from the XRAM or an external memory, the TestFlash may be selected instead of the user Flash memory (for details, please refer to ST10F269Zx errata sheet).

1.2.3 Same Flash memory Status Register

The Flash memory Status Register is used to flag the status of the Flash memory and the result of an operation.

To maximize the reuse of Flash memory programming software, the Flash memory Status Register of standalone Flash memories has been kept.

This register can be accessed by read cycles during Program/Erase Controller (P/E.C.) operations. Erase/program operations can be controlled by data polling on the FSB7 bit of the Status Register. Toggle detection is indicated on FSB6 and FSB2, error on FSB5 and erase timeout on the FSB3 bit. Any read attempt from the Flash memory during an erase or a program operation will automatically output these five bits. The P/E.C. sets bits FSB2, FSB3, FSB5, FSB6 and FSB7. Other bits are reserved for future use and should be masked.

Flash memory Status

Note: *The address of the Flash memory Status Register is the address of the word being programmed when a programming operation is in progress, or an address within the block being erased when an erasing operation is in progress.*

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
-	-	-	-	-	-	-	-	FSB.7	FSB.6	FSB.5	-	FSB.3	FSB.2	-	-
								R	R	R		R	R		

FSB.7 bit Flash Status Bit 7: Data Polling bit

Programming operation: this bit outputs the complement of the bit 7 of the word being programmed, and after completion, will output the bit 7 of the programmed word.

Erasing operation: outputs a '0' during erasing, and '1' after erasing completion.

If the block(s) selected for erasure is (are) protected, FSB.7 is set to '0' for about 100 µs, and then returns to the previous addressed memory data value.

FSB.7 also flags the Erase Suspend mode by switching from '0' to '1' at the start of Erase Suspend.

During program operation in Erase Suspend mode, FSB.7 has the same behavior as in normal program execution outside the Erase Suspend mode.

FSB.6 bit Flash Status Bit 6: Toggle bit

Programming or erasing operations: successive read operations of Flash Status register deliver complementary values. FSB.6 toggles each time the Flash Status Register is read. The program operation is completed when two successive reads yield the same value. The next read will output the last programmed bit, or a '1' after an erase operation.

FSB.6 is set to '1' if a read operation is attempted on an Erase Suspended block. In addition, an Erase Suspend/Resume command will cause FSB.6 to toggle.

FSB.5 bit Flash Status Bit 5: Error bit

This bit is set to '1' when there is a failure of a program, Block or Chip Erase operation. This bit is also set if a user tries to program a bit to '1' to a Flash memory location that is currently programmed with '0'.

The error bit is reset after a Read/Reset command.

In case of success, the Error bit is set to '0' during Program or Erase and then outputs the last programmed bit or a '1' after erasing.

FSB.3 bit Flash Status Bit 3: Erase Timeout bit

This bit is set to '1' by the P/E.C. when the last Block Erase command has been entered to the Command Interface and is awaiting the erase start. When the timeout period is finished, after 96 µs, FSB.3 returns to '1'.

FSB.2 bit Flash Status Bit 2: Toggle bit

This toggle bit, together with FSB.6, can be used to determine the chip status during the Erase or Erase Suspend mode. It can also be used to identify the block being Erase-Suspended. A Read operation will cause FSB.2 to Toggle during the Erase mode. If the Flash memory is in Erase Suspend mode, a read operation from the Erase-Suspended block or a program operation into the Erase-Suspended block will cause FSB.2 to toggle.

When the Flash memory is in program mode during Erase Suspend, FSB.2 will be read as '1' if address used is the address of the word being programmed.

After Erase completion with an error status, FSB.2 will toggle when reading the faulty sector.

1.2.4 Boot block architecture

The ST10F269Zx with a 0.35 µm embedded Flash memory has the same boot blocks as the M29F400 standalone Flash memory: 4 boot blocks (16 Kbyte, then 8 Kbyte, 8 Kbyte and 32 Kbyte).

1.2.5 Protection

Compared to standalone Flash memories, the ST10F269Zx with an embedded Flash memory provides 2 different protections:

- Block protection, as already implemented on ST standalone Flash memories, protects each block against inadvertent erasing,
- Code protection, is a set of new commands to protect the proprietary code written in the Flash memory: code protection disables data operand accesses and program branches from any location outside the embedded Flash memory.

The different protections are controlled through the Flash memory Protection Register. It is identical to the one of standalone Flash memories except for the code protection.

The Flash memory Protection Register is a non-volatile register that contains the protection status. This register can be read by using the Read Protection Status (RP) command, and programmed by using the dedicated Set Block/Code Protection commands.

Flash memory Protection Register (PR)

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
CP									BP6	BP5	BP4	BP3.3	BP2.2	BP1	BP0

BPx bits Block x Protection bit (x = 0...10)

'0': block protection is enabled for block x. Programming or erasing the block is not possible, unless a Block Temporary Unprotection command is issued.

'1': block protection is disabled for block x.

Bit is '1' by default, and can be permanently programmed to '0' using the Set Block Protection command but then cannot be set to '1' again. It is therefore possible to temporarily disable the block protection using the Block Temporary Unprotection command.

CP bit Code Protection bit

'0': Flash code protection is enabled. Read accesses to the Flash memory or execution not performed in the Flash memory itself are not allowed, the returned value will be 009Bh, whatever the contents of the Flash memory.

'1': Flash code protection is disabled: read accesses to the Flash memory from external or internal RAM are allowed

Bit is '1' by default, and can be programmed permanently to '0' using the Set Code Protection command but then cannot be set to '1' again. It is therefore possible to temporarily disable the code protection using the Code Temporary Unprotection command.

1.2.6 Operating modes

Unlike the standalone Flash memory, the ST10F269Zx embedded Flash memory has three different operating modes:

- User mode
- Bootstrap mode
- Test mode

These modes are selected upon reset by pulling down some specific lines of Port0. Since these modes do not exist in the standalone Flash memory, it is recommended to verify that the embedded Flash memory is in the right mode before erasing or programming it.

The EMUCON register shows which operating mode is active.

EMUCON(FE0Ah/ 05h)

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
-	-	-	-	-	-	-	-	TMOD1	TMOD2	TMOD3	x	x	x	x	x
								R	R	R					

TMOD1 bit TESTMODE1 Control bit

(EMUCON.7 '0': TESTMODE1 is not active

) '1': TESTMODE1 is active

This bit is set if P0L.2 = 0 during hardware reset.

TMOD2 bit TESTMODE2 Control bit

(EMUCON.6 '0': Bootstrap Loader is not active

) '1': Bootstrap Loader is active

This bit is set if P0L.[5..3] = 101 during hardware reset.

TMOD3 bit TESTMODE3 Control bit

(EMUCON.5 '0': TESTMODE3 is not active

) '1': TESTMODE3 is active

This bit is set if P0L.2[5..3] = 100 or 011 during hardware reset.

Note: Only 1 of these bits can be active at a time. The three bits are read-only.

Before performing any operation on the Flash memory, the user must verify that the Flash memory is really in the desired operating mode:

- To program the Flash memory in the Bootstrap mode, check that the TMOD2 bit is set
- To program the Flash memory in the User mode, check that all TMODx bits are cleared.

2 Writing code for the ST10F269Zx with 0.35 µm embedded Flash

2.1 ST10 programming constraints

2.1.1 Programming language

Direct addressing is not allowed for command sequences. All addresses of command cycles shall be defined only with **register-indirect** addressing mode.

As the compiler may generate indirect addressing, the part of the software that generates the **commands to the Flash memory should be written in assembly**. Still, the part of the software that is not generating the commands can be in higher-level language (e.g.: C).

Indirect addressing

For command instructions, address bits A14, A15, A16 and A17 are don't care, provided that the generated address falls within the Flash memory space.

This is used to simplify the use of DPP registers when generating commands to the Flash memory: any DPP already pointing to data in the Flash memory space can be used to write commands to the Flash memory.

- **Tip:** It is also possible to use the extended segment or extended page instructions for addressing the Flash memory.

2.2 Polling the Flash memory Erase/Program Controller

As soon as the Erase/Program Controller (E./P.C.) receives the last command of a command sequence, it starts executing the command. During command execution, the E./P.C. status is indicated by 2 sources:

- The Flash memory Status Register
- The Ready/Busy signal

The Flash memory automatically resumes the read mode after the completion of the command.

2.2.1 Ready/Busy signal

The Ready/Busy ($\overline{R/B}$) signal is connected to the XPER2 interrupt node (XP2IC). When $\overline{R/B}$ is high, the Flash memory is busy with a program or erase operation and will not accept any additional program or erase instruction. When $\overline{R/B}$ is low, the Flash is ready for any read/write or erase operation. The $\overline{R/B}$ is also low when the memory is put in Erase Suspend mode.

This signal can be polled by reading the XP2IC register, or can be used to trigger an interrupt when the Flash memory goes from Busy to Ready.

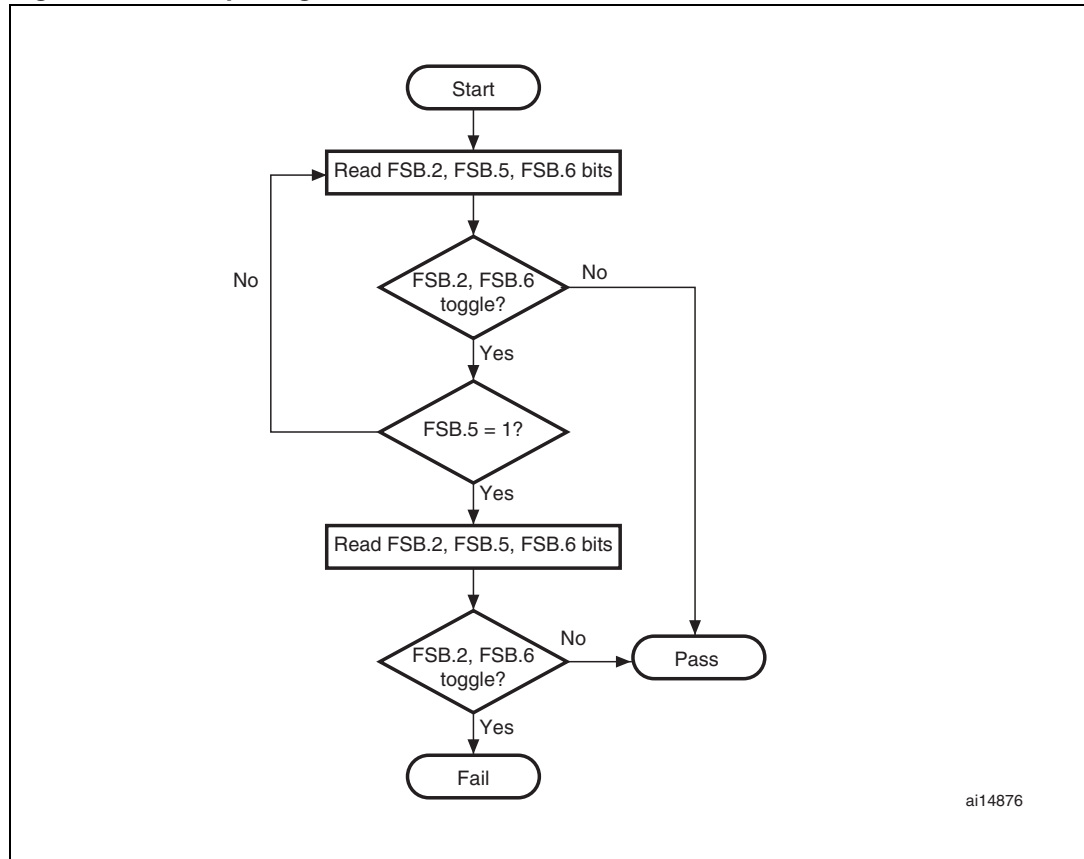
This feature may not be available for all ST10 variants in 0.35 µm Flash memory technology. Please, check the product datasheet.

2.2.2 Flash memory Status Register

The Flash memory Status Register is described in [Section 1.2.3: Same Flash memory Status Register](#).

This method of polling the ST10F269Zx embedded Flash memory is recommended and used in the code examples in this document. There is another method to verify the completion of a Flash memory operation, it is called the “data polling flow”. It uses the Toggle bit of the Flash Status Register. The algorithm is described in the figure below.

Figure 1. Data polling flow



The two read accesses to the Flash memory Status Register must be made consecutively. The following sequence must be executed:

```

EXTS   Ra, #1    ;use EXTended addressing for next MOV instruction
MOV     Ry, [Rx]  ;read Flash Status register (FSB) in Ry
EXTS   Ra, #1    ;use EXTended addressing mode for next MOV instruction
MOV     Rz, [Rx]  ;read Flash Status register (FSB) in Rz
  
```

Then, the Rz and Ry registers are compared to check the toggling of the bit.

2.3 Flash memory mapping in the ST10F269Zx memory space

As defined for all ST10 derivatives, the lower 32 Kbyte part of the embedded Flash memory can be mapped to two different segments.

The Flash memory mapping is controlled by the ROMS1 bit in the SYSCON register.

Table 2. Flash memory block mapping (lower 32 Kbytes of memory)

Block ⁽¹⁾	Addresses (Segment 0)	Addresses (Segment 1)	Size (Kbytes)
0	00 0000h to 00 3FFFh	01 0000h to 01 3FFFh	16
1	00 4000h to 00 5FFFh	01 4000h to 01 5FFFh	8
2	00 6000h to 00 7FFFh	01 6000h to 01 7FFFh	8

1. The memory mapping of the other block is independent of the ROMS1 bit.

2.4 Program command

In the examples hereafter, the 16-bit registers R11 and R12 are used as auxiliary registers for indirect addressing.

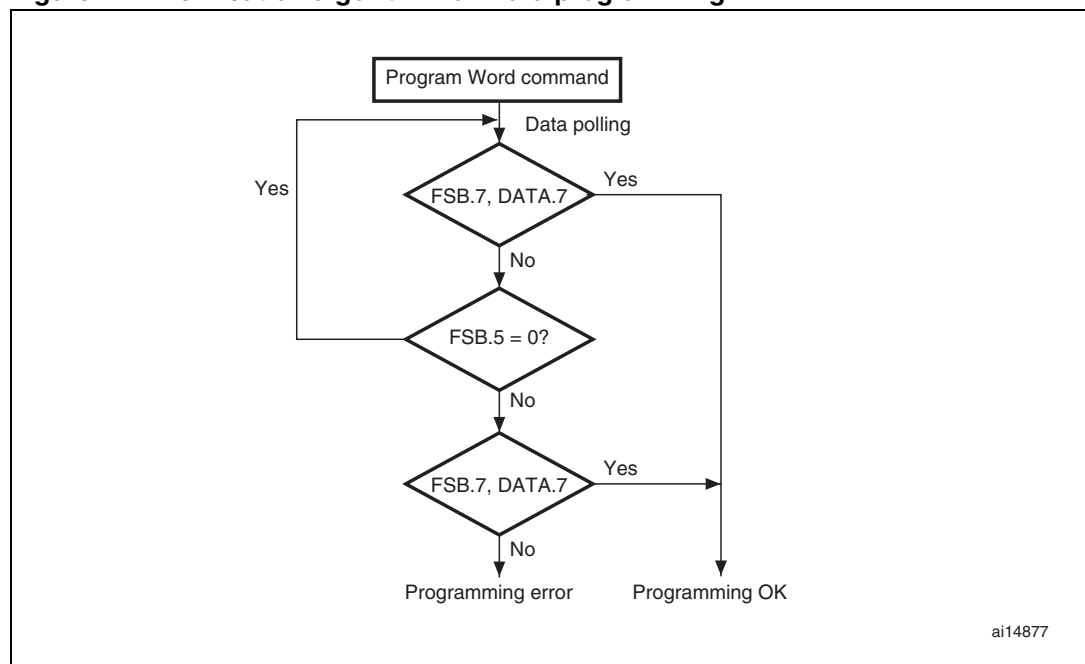
The following examples use DPP0. All that is needed is to make sure that DPP0 points to the active Flash memory area.

To be independent of the mapping of sector 0, DPP is set to point to segment 2 (that is: DPP0 = 08h).

Note: The NOP instruction must be added after the last erase or program command to avoid the ST10 pipeline effect (see [Flash commands and ST10 pipeline effect on page 8](#)).

[Figure 2](#) shows the algorithm for word programming verification.

Figure 2. Verification algorithm for word programming



Example: Performing a Program Word command

Let us assume that in the initialization phase the lowest 32 Kbytes of Flash memory (sector 0) have been mapped to segment 1. The data to be written is loaded into register R13, the address to be programmed is loaded into registers R11/R12 (segment number into R11, segment offset into R12).

```

; sending of the programming command to the Flash
MOV   R5, #01554h ;load auxiliary register R5 with command address
                        ;(used in command cycle 1)
MOV   R6, #02AA8h ;load auxiliary register R6 with command address
                        ;(used in command cycle 2)
SXCT  DPP0, #08h  ;push data page pointer 0 and load it to point
                        ;to segment 2
MOV   R7, #0A8h   ;load register R7 with 1st CI enable command
MOV   [R5], R7    ;command cycle 1
MOV   R13, #054h  ;load register R7 with 2nd CI enable command
MOV   [R6], R7    ;command cycle 2
MOV   R13, #0A0h  ;load register R7 with Program Word command
MOV   [R5], R7    ;command cycle 3
POP   DPP0        ;restore DPP0: following addressing to the Flash
                        ;will use EXTended instructions
                        ;R11 contains the segment to be programmed
                        ;R12 contains the segment offset address to be programmed
                        ;R13 contains the data to be programmed
EXTS  R11, #1     ;use EXTended addressing for next MOV instruction
MOV   [R12], R13 ;command cycle 4: the E/P.C. starts execution of
                        ;program command
NOP                                ;pipeline effect: make sure there is no JMPx, no
                        ;no JMPx, no RETx or no CALLx instruction here

; Data Polling after word programming:
data_polling:
EXTS  R11, #1     ;use EXTended addressing for next MOV instruction
MOV   R7, [R12]  ;read Flash Status register (FSB) in R7
MOV   R6, R7     ;save it in R6 register
                        ;Check if FSB.7 = Data.7 (i.e. R7.7 = R13.7)
XOR   R7, R13
JNB   R7.7, Prog_OK

                                ;Check if FSB.5 = 1 (Programming Error)
JNB   R6.5, Data_Polling
                                ;Programming Error: verify is Flash programmed data is OK
EXTS  R11, #1     ;use EXTended addressing for next MOV instruction
MOV   R7, [R12]  ;read Flash Status register (FSB) in R7
                                ;Check if FSB.7 = Data.7
XOR   R7, R13
JNB   R7.7, Prog_OK
                                ;Programming failed: Flash remains in Write Operation.
                                ;To go back to normal Read operations, a Read/Reset
                                ;command must be performed

Prog_Error:
MOV   R7, #0F0h  ;load register R7 with Read/Reset command
EXTS  R11, #1     ;use EXTended addressing for next MOV instruction
MOV   R12], R7   ;address is don't care for Read/Reset command
...
...
...
                                ;When programming operation finished succesfully, Flash is set
                                ;back automatically to normal Read Mode

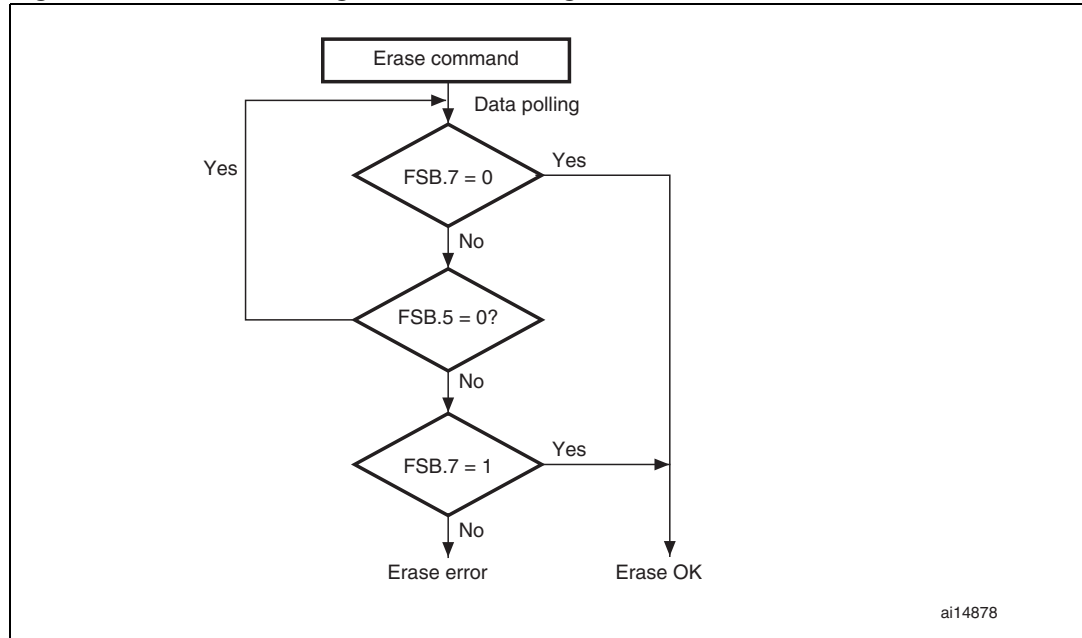
Prog_OK:
....
....

```

2.5 Erase commands

Figure 3 shows the algorithm for erasing verification.

Figure 3. Verification algorithm for erasing



Example: Performing the Block Erase command.

Let us assume that in the initialization phase the lowest 32 Kbytes of Flash memory (sector 0) have been mapped to segment 1. The R11/R12 registers contain an address related to the block to be erased (segment number in R11, segment offset in R12, e.g.: R11 = 01h, R12= 4000h will erase block 1 - first 8 Kbyte block).

; sending of the erasing command to the Flash

```

MOV   R5, #01554h    ;load auxiliary register R5 with command address
                        ;(used in command cycle 1)
MOV   R6, #02AA8h    ;load auxiliary register R6 with command address
                        ;(used in command cycle 2)
SXCT  DPP0, #08h     ;push data page pointer 0 and load it to point
                        ;to segment 2
MOV   R7, #0A8h      ;load register R7 with 1st CI enable command
MOV   [R5], R7        ;command cycle 1
MOV   R13, #054h     ;load register R7 with 2nd CI enable command
MOV   [R6], R7        ;command cycle 2
MOV   R13, #080h     ;load register R7 with Block Erase command
MOV   [R5], R7        ;command cycle 3
MOV   R7, #0A8h      ;load register R7 with 1st CI enable command
MOV   [R5], R7        ;command cycle 4
MOV   R13, #054h     ;load register R7 with 2nd CI enable command
MOV   [R6], R7        ;command cycle 5
POP   DPP0           ;restore DPP0: following addressing to the Flash
                        ;will use EXTended instructions
                        ;R11 contains the segment of the block to be erased
                        ;R12 contains the segment offset address of the block
MOV   R7, #030h      ;load register R7 with erase confirm code
EXTS  R11, #1         ;use EXTended addressing for next MOV instruction
MOV   [R12], R7      ;command cycle 6: the E/P.C. starts execution of ;Erase
                        Command after 96µs timeout delay
  
```



```

                                ;additional block commands may be sent here before the ;96 µs
                                timeout expires.
; erase polling during block erase
Erase_Polling:
EXTS R11, #1                    ;use EXTended addressing for next MOV instruction
MOV  R7, [R12]                  ;read Flash Status register (FSB) in R7
                                ;Check if FSB.7 = '1' (i.e. R7.7 = '1')
JB   R7.7, Erase_OK

                                ;Check if FSB.5 = 1 (Erasing Error)
JNB  R7.5, Erase_Polling
                                ;Programming failed: Flash remains in Write Operation.
                                ;To go back to normal Read operations, a Read/Reset ;command
                                must be performed

Erase_Error:
MOV  R7, #0F0h                  ;load register R7 with Read/Reset command
EXTS R11, #1                    ;use EXTended addressing for next MOV instruction
MOV  [R12], R7                  ;address is don't care for Read/Reset command
...                                ;here place specific Error handling code
...
...

                                ;When erasing operation finished successfully, Flash is ;set back
                                automatically to normal Read Mode

Erase_OK:
....
....

```

2.6 Flash protection commands

2.6.1 Set Block Protection

The Set Block Protection command is used to protect the internal Flash memory blocks against inadvertent erasing and/or programming.

For security reasons, once set, the protection cannot be removed, even after erasing the Flash memory. It can only be temporarily disabled using the Block Temporary Unprotection command.

2.6.2 Set Code Protection

the Set Code Protection command is used to disable any read or jump to the ST10 embedded Flash memory from another memory (like internal RAM, external memory).

For security reasons, once set, the code protection is permanent and cannot be cleared, even after erasing the Flash memory. Code protection can only be temporarily disabled using the Code Temporary Unprotection command.

Code Temporary Unprotection remains active until a Code Temporary Protection command is executed or until reset (reset via the Flash Command Interface, hardware, software, watchdog).

Using code protection with ST10

When code protection is set, and when code may be executed from another memory before resuming code execution from the on-chip-Flash memory, the code protection should be disabled before calling the routine in the other memory. If not, a Trap #00 illegal instruction will be generated when jumping back to the on-chip Flash memory.

Code protection and bootstrap loader

The code protection also applies in bootstrap mode: in ST10 bootstrap loader mode, it is not possible to read the Flash memory or to jump to any address within the embedded Flash memory.

Code protection and block 0 protection

When code protection is set, it is no longer possible to dump the Flash memory contents. In addition, code protection also protects all blocks against erroneous erase or program.

When code protection is set, the Code Temporary Unprotection command should be executed prior to any erase or program command. As explained before, this command should be executed with the code running from the Flash memory.

Example: Performing the Read Protection Status command

```
,*****
;Read_Block_Protection
;INPUT : NONE
;OUTPUT: R0 contain the status of each block (if bit x is set, block x is protected)
,*****
Read_Block_Protection proc near
    ; R0 = segment of Flash
    push R1 ; R1 = First addr to write
    push R2 ; R2 = Second addr to write
    push R3 ; R3 = Data
    push R4 ; R3 = Data
    push R5 ; R5 = pointer to data status

    mov R0, dpp2:Flash_Seg
    mov R1, #Even_comm ; Retrieve the even command addr
    mov R2, #Odd_comm; Retrieve the odd command addr
    mov R3, #Val1
    exts R0, #1
    mov[R1],R3; First write
    mov R3, #Val2
    exts R0, #1
    mov[R2],R3; second write
    mov R3, #090h
    exts R0, #1
    mov[R1],R3; third write
    MOV R2,#8; R2 contain the number of block that remain to read
    MOV R3,#0; R3 will contain the status
    MOV R4,#1; R4 Mask for status
    MOV R1, R0
    EXTS #MONITOR_SEG,#1
    MOVR5, #flash_status

    POP R5 ; R5 = pointer to data status
    POP R4
    POP R3
    POP R2
    POP R1
    RET
Read_Block_Protection ENDP
```

Code protection and Read Protection Status command

The Read Protection Status command clears the effect of a previous Code Temporary Unprotection command.

2.7 Other Flash memory commands

Example: Performing the Read/Reset command

Let us assume that in the initialization phase the lowest 32 Kbytes of Flash memory (sector 0) have been mapped to segment 1.

According to the usual way of ST10 data addressing with data page pointers, address bits A15 and A14 of a 16-bit command write address select the data page pointer (DPP) which contains the upper 10 bits to build the 24-bit physical data address. Address bits A13...A0 represent the address offset. As the bits A14...A17 are don't care when writing a Flash memory command in the Command Interface (CI), we can choose the most convenient DPPx register for address handling.

The following examples are making use of DPP0. All that is needed is to make sure that DPP0 points to the active Flash memory space.

To be independent of the mapping of sector 0, **all** the DPPs used for Flash memory address handling are set to point to segment 2.

For this reason DPP0 is loaded with value 08h (00 0000 1000b).

```
MOV   R5, #01554h    ;load auxiliary register R5 with command address
                        ;(used in command cycle 1)
MOV   R6, #02AA8h    ;load auxiliary register R6 with command address
                        ;(used in command cycle 2)
SCXT  DPP0, #08h     ;push data page pointer 0 and load it to point
                        ;to segment 2
MOV   R7, #0A8h      ;load register R7 with 1st CI enable command
MOV   [R5], R7        ;command cycle 1
MOV   R7, #054h      ;load register R7 with 2cd CI enable command
MOV   [R6], R7        ;command cycle 2
MOV   R7, #0F0h      ;load register R7 with Read/Reset command
MOV   [R5], R7        ;command cycle 3. Address is don't care
POP   DPP0            ;restore DPP0 value
```

2.8 Tips to reduce Flash memory programming and erase times

2.8.1 Reducing the programming time

When block protection is enabled, Block Temporary Unprotection commands shall be sent before any erase or program command.

As block unprotection remains active till the next reset, this means it is not necessary to repeat the command for each word to program.

2.8.2 Reducing erase times

Reducing the erase time is simple with ST10F269Zx 0.35 µm embedded Flash memory. Several charge pumps are provided for each block, so erasing two blocks does not take twice as long as erasing one block (erasing 2 blocks still takes longer than erasing one block however). To benefit from the parallel erase, it is important to issue all the blocks you want with one Block Erase command. The Chip Erase command also erases the blocks in parallel.

Erasing a block of data

Erase commands perform two operations: first, they individually program each word to 0000h, then they use the tunnelling to set all bits to "1" at the same time. The time taken to erase a block can be reduced by more than 50% if all word are already programmed to 0000h.

This specificity can be used in applications where blocks of data are copied from 1 block to another and the old block is marked as "dirty". Writing all data to 0000h in a "dirty" block will save time when this block will be erased.

3 Embedded application aspects

This section advises for embedded applications where the ST10F269Zx embedded Flash memory may be the only non-volatile memory available.

Reading the Flash memory while programming and field reprogramming are the two specific points raised by single-chip embedded applications.

3.1 Reading the Flash memory while erasing or programming

During erasing or programming, the entire Flash memory is not visible to the CPU, whatever the Flash memory block being erased or programmed. As a consequence on ST10F269Zx software:

- During erasing and programming, it is not possible to have access to the interrupt vector table and so all interrupts shall be disabled.
- Before erasing and programming, a small software loop shall be copied from the Flash memory to the on-chip RAM to run the minimum code needed to wait for the end of erasing or programming.
- If code protection is activated, it should be temporarily disabled before executing the code copied into the on-chip RAM.

There are two ways of dealing with this constraint: one consists in minimizing the requirements in RAM space during erasing/programming, and the other consists in maximizing the programming speed by duplicating all needed software into the on-chip RAM.

3.1.1 Minimum software to be copied into the on-chip RAM

The minimum software to be copied into the on-chip RAM is:

- Functions sending the erasing and/or programming commands to the ST10F269Zx embedded Flash memory,
- Functions polling the Flash memory Status Register for completion of the command and for error (see detailed specification).

Example of use: This method can be implemented when it is necessary to program and/or erase some data in the ST10F269Zx embedded Flash memory during normal operation.

3.1.2 Maximizing programming performance at system level

When the minimum software is copied into the on-chip RAM, during erasing and/or programming, the CPU cannot run any other software (like communication).

To maximize the programming performance, the user could handle the whole part or only part of the communication handler. This requires:

- That more software is copied into the on-chip RAM,
- The communication handler is not using interrupts,
- The software loop polling the Flash memory Status Register is modified to handle the Communication process.

Example of use: This method can be implemented when it is necessary to erase and program (reprogram) the whole ST10F269Zx Flash memory.

3.1.3 Erase Suspend and Resume commands

Like in standalone Flash memories, the 0.35 μm embedded Flash memory controller features suspend and resume commands. These commands are used to suspend the erasing or programming process at any time, and resume it later on.

Once the suspend command is complete, the ST10F269Zx can access a needed software routine (the communication driver) which has not been relocated in the on-chip RAM.

Example of use: the error handler of the communication driver.

Note: The time during which the Flash memory is not available is unchanged but this gives the possibility of suspending the process to run specific routines during Flash memory erasing or programming (e.g.: communication protocol).

3.2 Field reprogramming with ST10F269Zx

Reprogramming in the field part or the whole application requires to be able to deal safely with all the events that may occur in the field while the Flash memory is being reprogrammed.

This analysis is application-dependent and has to be carefully conducted by the user. This section assumes that users are experienced with all the generic aspects of field reprogramming and will focus only on the ST10F269Zx specific events.

3.2.1 Field events and Flash memory reliability

The user applications must meet ST's recommendations for Flash memory programming and erasing. Failure to do so could result in lower data retention and/or altered Flash memory reliability. The conditions leading to an altered data retention or to an altered reliability depend on the command issued to the Flash memory and the event that occurred during this command (supply out of range, reset).

From the FMEA (failure modes and effects analysis) perspective, customers should consider that when ST's advice is not implemented, the Flash memory reliability can be altered. When ST's advice is implemented, and provided that all field-specific events are within ST recommendations (see hereafter), the Flash memory will meet ST's published specification.

3.2.2 Reset

Whatever the possible causes of reset (spurious reset, external hardware reset, reset due to power shutdown), Reset is one of the events that may happen during field reprogramming.

Reset and boot block

Reset may occur at any time and there is no way of preventing this. Reset may occur during the reprogramming of the boot block (block 0) and thus leave invalid data/code inside this block.

Suggested method of handling: as reset may occur during the erasing of the on-chip Flash memory before it is reprogrammed, the ST10F269Zx should be able to read a valid code from the Flash memory at the next startup.

As a consequence:

- Block 0 (that starts at physical address: 00 0000h) should never be erased during field reprogramming.
- Block 0 should contain all the routines that make it possible to restart the reprogramming routines (if those routines are in another block, this block also should never be erased).

Note: This restriction on block 0 does not apply if the ST10F269Zx Bootstrap Loader mode is used for field reprogramming (see [Code protection and bootstrap loader on page 18](#) paragraph if code protection is used).

Flash block write protection

It is recommended to use the Flash memory Set Block Protection command to protect the block(s) which contains all the needed software to restart the reprogramming routines. Any inadvertent Chip Erase command will not affect those protected blocks.

Reset and other blocks

Suggested method of handling: reset during erase and/or program should be detected externally. In such a case, the entire "erasing" or "erasing + programming" process should be restarted. Detection of reset during erasing or reprogramming should be done by external resources (hardware, protocol between ST10 and the programming station).

3.2.3 List of events and suggested handling methods

Supply variations

The ST10F269Zx supply must remain within the supply voltage range specified in the published datasheet during any erase or program command.

Detection method

Specific hardware should be added to monitor the supply, and reset the device when the ST10F269Zx supply is going out of the functional specification (see datasheet).

Suggested handling method

Restart the whole reprogramming sequence at module level (i.e.: erasing + programming).

Note: As for any other parameter, the ST10F269Zx supply should stay within the maximum absolute ratings defined in the published datasheet.

Temperature out of specification

Temperature during erase, program and operation has an influence on the reliability of ST10F269Zx devices.

The embedded Flash memory may be programmed and erased only while the junction temperature is within the range specified in the ST published datasheet (see ST10F269Zx datasheet).

Failure to keep the device within the temperature ranges specified in the product datasheet could result in degraded reliability (lower number of erase cycles, lower data retention).

ST10 PLL unlock

As the Flash memory programming/erasing timings are not defined by the ST10F269Zx, PLL unlock has no effect on Flash memory erasing and programming. Usually, PLL unlock stops communication because of the change in bit/ baud rate.

Detection method

Not necessary from the ST10F269Zx point of view (to be checked with application specific constraints).

Suggested handling method

Restart the whole programming sequence (that is, at module level).

3.2.4 Generic aspects of Flash field reprogramming

This section gives some advice for field reprogramming. This advice is not specific to the ST10F269Zx, they are generic to any embedded application that reprograms itself using a communication medium with a programming station.

The main points to control during Flash reprogramming are:

- Completion of the reprogramming process itself,
- Events that may interrupt the reprogramming process.

Completion of the reprogramming process

The programming process is completed when the last word to be programmed has been programmed correctly (that is: status returned by the Flash memory is OK). If, for any reason, the programming process is interrupted during the programming of the last word, the value written may be logically good at the next restart, but as the programming was interrupted before completion, the data retention for this last word will be reduced.

For this reason, it is recommended that users consider the reprogramming as "OK" only after the completion of the programming of the last word (e.g.: sending of an acknowledge to the programming station after the last word has been successfully programmed).

Evidence of the successful completion of the programming process

For traceability reasons, some users may want to record an evidence of the successful completion of the reprogramming process.

This can be done by programming a variable into the Flash memory after the last valid word to be programmed has been successfully programmed.

Events that may interrupt the reprogramming process

The previous paragraphs have given advice on events that may interrupt the reprogramming process. Some other events, not described above, may occur.

The handling of those events, at module level and at ST10F269Zx level, should be such that the events are detected as soon as possible and that the ST10F269Zx is able to restart the programming process.

On the ST10F269Zx side, as bank 0 is never erased, it is possible to restart the programming process (assuming that all banks that have the code needed for reprogramming are never erased).

Restarting reprogramming

When interrupted, it is recommended to restart the reprogramming process from the beginning (that is erasing **and** programming).

3.3 Ruggedized aspects

Some embedded applications need to be ruggedized to cope with some market specificities. Application ruggedization is usually done by following a set of rules defined for each project (e.g.: power-on self tests).

This section describes hints that are suggested when designing a ruggedized application.

3.3.1 Checksum

Some applications may have routines that are used to reprogram the Flash memory in the field. For such applications, if the software goes out of control and jumps by mistake to those routines, there is, theoretically, a possibility that the Flash memory is modified by mistake during this time. Ruggedization could be done by having a checksum computed over the entire Flash memory content.

3.3.2 Initialization of unused memory locations

In the unlikely event that the application software is going out of control, unused memory locations could be initialized to an illegal ST10 opcode. In this event, the processor is stopped by an illegal opcode trap as soon as the execution code jumps by mistake to an unused memory location.

4 Quick summary

This section gives a quick summary on ST10F269Zx programming for 0.35 μm embedded Flash memory:

Addressing: indirect register addressing needed to send commands to the embedded Flash memory.

Programming language: can be high-level (e.g.: C) except for the writing of the commands: must be assembly to ensure that indirect register addressing is used.

Polling the Flash memory Erase/Program Controller: preferred solution is via the Flash memory Status Register. For increased software reuse for coming ST10 variants, check that reserved bits are masked by software.

Code run from RAM: the commands for erasing, programming and polling the completion of the commands should be run from the on-chip RAM.

Interrupt disabled: no interrupt enabled during the execution of commands in the Flash memory.

Code protection: once set, it is no more possible to dump the Flash memory contents using code executed from another memory (external Flash, on-chip RAM during bootstrap mode).

5 Conclusion

This application note has shown how easy it is to erase and program the ST10F269Zx.

ST10F269Zx microprocessors with 0.35 μm single voltage embedded Flash memories are ideal for embedded applications where performance, security and reprogrammability are needed.

6 Revision history

Table 3. Document revision history

Date	Revision	Changes
06-Mar-2008	1	Initial release.

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